



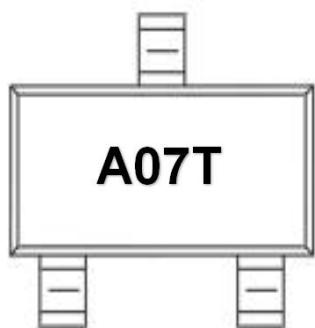
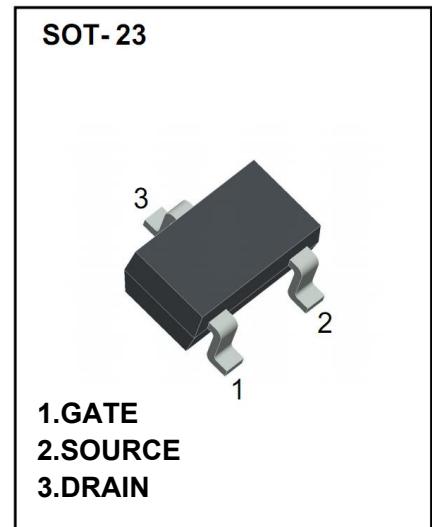
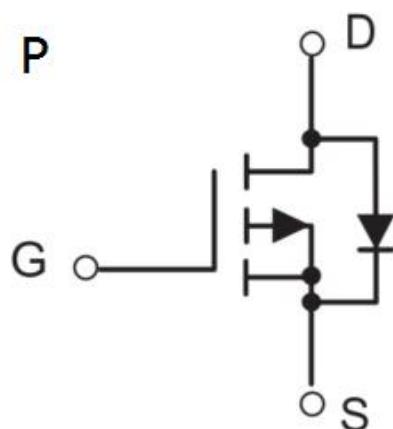
SHENZHEN MENGKE ELECTRONICS TECHNOLOGY CO.,LTD

SOT-23 Plastic-Encapsulate MOSFETS**MK2307****P-Channel 30-V(D-S) MOSFET**

V(BR)DSS	RDS(on)MAX	ID
-30 V	73mΩ@-10V 100mΩ@-4.5V	-4.1A

FEATURE

※ TrenchFET Power MOSFET

APPLICATION※ Load Switch for Portable Devices
※ DC/DC Converter**MARKING****Equivalent Circuit****Maximum ratings (Ta=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	VDS	-30	V
Gate-Source Voltage	VGS	±20	
Continuous Drain Current	ID	-4.1	A
Pulsed Diode Current	IDM	-20	
Continuous Source-Drain Current(Diode Conduction)	IS	-1	
Power Dissipation	PD	0.5	W
Thermal Resistance from Junction to Ambient (t≤5s)	R _{θJA}	417	°C/W
Operating Junction	T _J	150	°C
Storage Temperature	T _{STG}	-55~+150	°C



MOSFET ELECTRICAL CHARACTERISTICS

Static Electrical Characteristics ($T_a = 25^\circ\text{C}$ Unless Otherwise Noted)

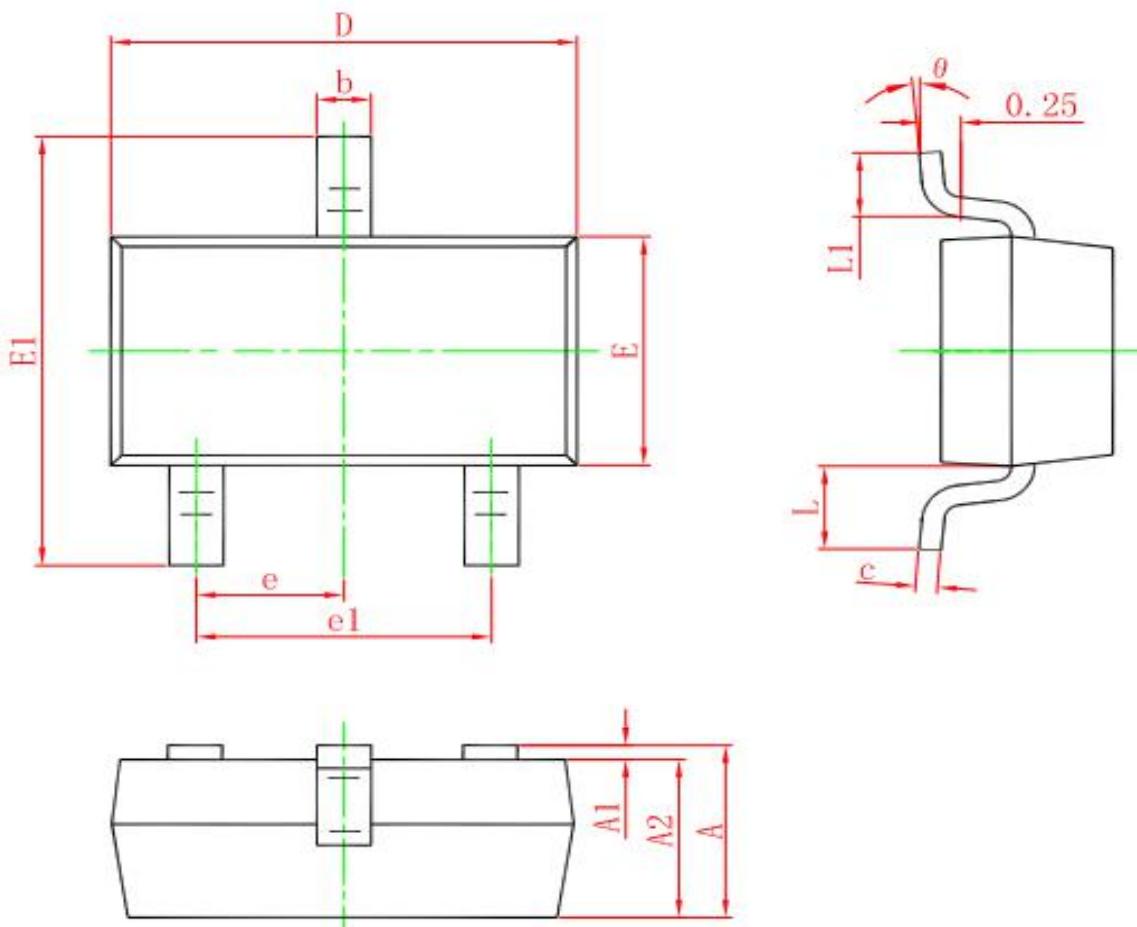
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-source breakdown voltage	V(BR)DSS	$V_{GS} = 0V, ID = -250\mu\text{A}$	-30			V
Gate-source threshold voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, ID = -250\mu\text{A}$	-1		-3	V
Gate-source leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$			± 100	nA
Zero gate voltage drain current	I_{DSS}	$V_{DS} = -30V, V_{GS} = 0V$			-1	μA
Drain-source on-state resistancea	RDS(on)	$V_{GS} = -10V, ID = -4.1\text{A}$		60	73	$\text{m}\Omega$
		$V_{GS} = -4.5V, ID = -3.5\text{A}$		87	100	$\text{m}\Omega$
Forward transconductancea	g_{fs}	$V_{DS} = -5V, ID = -4\text{A}$	6			S
Diode forward voltage	V_{SD}	$IS = -1\text{A}, V_{GS} = 0V$		-0.8	-1.2	V
Dynamic						
Input capacitance	C_{iss}	$V_{DS} = -15V, V_{GS} = 0V, f = 1\text{MHz}$		700		pF
Output capacitance	C_{oss}			120		pF
Reverse transfer capacitanceb	C_{rss}			75		pF
Total gate charge	Q_g	$V_{DS} = -15V, V_{GS} = -10V, ID = -4.1\text{A}$		4.2		nC
Gate-source charge	Q_{gs}			1.5		nC
Gate-drain charge	Q_{gd}			2		nC
Gate resistance	R_g	$f = 1\text{MHz}$		10		Ω
Switchingb						
Turn-on delay time	$t_{d(on)}$	$V_{DD} = -15V, RL = 10\Omega, ID = -1.5\text{A}, V_{GEN} = -10V, R_g = 1\Omega$		8.6		ns
Rise time	t_r			5		ns
Turn-off delay time	$t_{d(off)}$			28.2		ns
Fall time	t_f			13.5		ns
Drain-source body diode characteristics						
Continuous Source-Drain Diode Current	I_S	$T_c = 25^\circ\text{C}$			-1.2	A
Pulsed Diode forward Current	I_{SM}				-10	A

Note :

1. Repetitive Rating : Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t < 5$ sec.
3. Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production testing.



SOT-23 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°